

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Semiconductor Leading Edge Technologies, Inc.	04/20/2005
RECEIVING PARTY DATA	
Name:	Sanyo Electric Co., Ltd.
Street Address:	5-5, Keihan Hondori 2-chome
City:	Moriguchi-shi, Osaka
State/Country:	JAPAN
Postal Code:	570-8677
PROPERTY NUMBERS Total: 4	
Property Type	Number
Application Number:	10812420
Application Number:	10863395
Application Number:	10920360
Application Number:	11010344
CORRESPONDENCE DATA	
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Address Line 4:	Washington, DISTRICT OF COLUMBIA 20005
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CH \$160.00 10812420

Total Attachments: 2
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ASSIGNMENT

WHEREAS **Semiconductor Leading Edge Technologies, Inc.**, of 16-1 Onogawa, Tsukuba-shi, Ibaraki, 305-8569, Japan (hereinafter "Assignor") is the owner of the following United States Patent Applications, and the inventions set forth therein, as shown by the records of the United States Patent and Trademark Office:

U.S. PATENT APPLICATION NO.	FILING DATE
10/812,420	March 30, 2004
10/863,395	June 9, 2004
10/920,360	August 18, 2004
11/010,344	December 14, 2004

WHEREAS **Sanyo Electric Co., Ltd.**, of 5-5, Keihan Hondori 2-chome, Moriguchi-shi, Osaka 570-8677 Japan (hereinafter referred to as "Assignee") is desirous of acquiring Assignor's entire right, title and interest in and to said invention for the United States of America, and in and to said United States Patent Application;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged by Assignor, Assignor has sold, assigned, transferred and sets over, and by these presents hereby sells, assigns, transfers and sets over to Assignee, Assignor's entire and exclusive right, title and interest in and to the Patent Applications for the United States of America listed above, all Letters Patent issuing therefrom, including all continuations, divisions, and extensions thereof, reissues, and reexaminations thereof, all rights, covenants, and obligations under any and all licenses granted for the Patent Applications identified above and all Letters Patent issuing therefrom; and all past, present, and future claims for damages by reason of patent infringement thereof with the right to sue for and collect the same for Assignee's own use, such right, title, and interest to be held and enjoyed by Assignee, its successors and assigns, to the full end of the terms for all Letters Patent issuing from the Patent Applications identified above as fully and entirely as would have been held and enjoyed by Assignor had this Agreement not been made.

Assignor hereby authorizes and requests the U.S. Commissioner of Patents to issue any and all such Letters Patent, reissue patents, and reexamination certificates that may result, to the full extent of Assignor's interest, to said Assignee, its successors or assigns in accordance herewith;

Assignor warrants and covenants that it has the full and unencumbered right to sell and assign the interests herein sold and assigned, and that it has not executed and will not execute any document or instrument in conflict herewith;

Assignor further covenants and agrees that it will communicate to Assignee, its successors, legal representatives or assigns all information known to Assignor relating to said inventions and Patent Applications and that it will, at Assignee's expense, execute and deliver any papers, make all rightful oaths, testify in any legal proceedings, and perform all other lawful acts deemed necessary or desirable by said Assignee, its successors, legal representatives or assigns to perfect title to said Patent Application, or to assist said Assignee, its successors, legal representatives or assigns in obtaining, reissuing or enforcing all such Letters Patent;

The undersigned hereby grant the firm of Leydig, Voit & Mayer the power and authority to insert in this Assignment any further identification which may be necessary or desirable to comply with the rules of the U.S. Patent and Trademark Office for recordation of this Assignment.

**Semiconductor Leading Edge
Technologies, Inc.**

Date: April 20, 2005

By: Hiroomi Sakurai

Name: Hiroomi SAKURAI
Title: Director, General Manager,
Research Planning Promotion

Affirmed and Agreed to:

Sanyo Electric Co., Ltd.

Date: May 9, 2005

By: Nagatoshi Sugihara

Name: Nagatoshi Sugihara
Title: R&D Headquarters
Planning and Administration Office
Intellectual Property Department
General Manager